



*materials*



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## Advanced Materials and Devices for Applied System Innovation

Guest Editors:

**Prof. Dr. Sheng-Joue Young**

**Prof. Dr. Liang-Wen Ji**

**Dr. Yen-Lin Chu**

**Dr. Yi-Hsing Liu**

**Dr. Stephen D. Prior**

### Message from the Guest Editors

In recent years, the applications of advanced materials have been highly-developing fields, notably, in the areas of semiconductor and electronic device technology, design, manufacturing, physics, and modeling. Therefore, the fields of electrical and mechanical materials have always been hot research areas. The scopes not only encompass material sizes at the nanoscale but also in various dimensions, where the onset of size-dependent phenomena usually enables novel applications.

Deadline for manuscript  
submissions:  
**closed (10 November 2023)**

Excellent papers with relevant topics are welcomed, including fundamental and advanced materials of electrical and mechanical engineering, their synthesis and engineering, their application in optical sensors, magnetic, acoustic, and thermal transduction, their integration with many elements, designing of electrical or mechanical devices, evaluation various performance and exploring their broad applications in industry, environmental control, material analysis, etc.



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# Special Issue



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## Message from the Editor-in-Chief

*Materials* (ISSN 1996-1944) was launched in 2008. The journal covers twenty-five comprehensive topics: biomaterials, energy materials, advanced composites, advanced materials characterization, porous materials, manufacturing processes and systems, advanced nanomaterials and nanotechnology, smart materials, thin films and interfaces, catalytic materials, carbon materials, materials chemistry, materials physics, optics and photonics, corrosion, construction and building materials, materials simulation and design, electronic materials, advanced and functional ceramics and glasses, metals and alloys, soft matter, polymeric materials, quantum materials, mechanics of materials, green materials, general. *Materials* provides a unique opportunity to contribute high quality articles and to take advantage of its large readership.

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